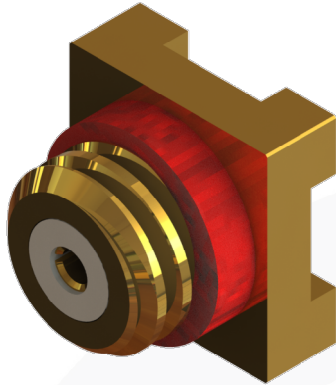
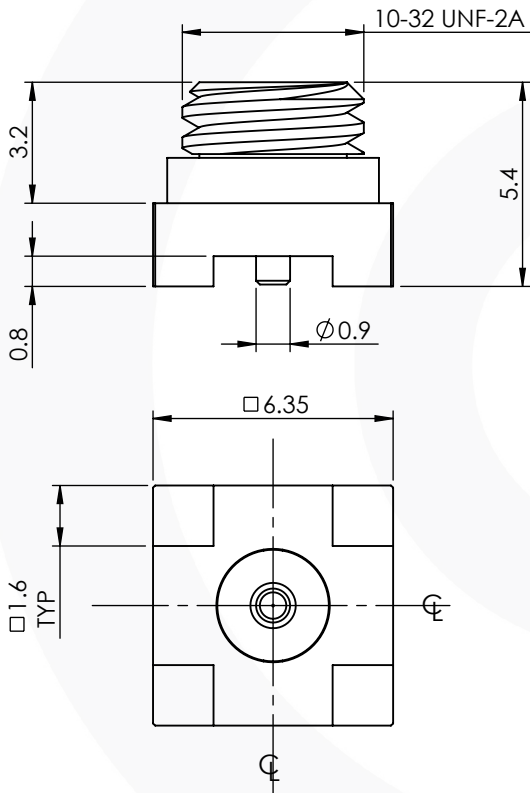


10-32 SMT JACK

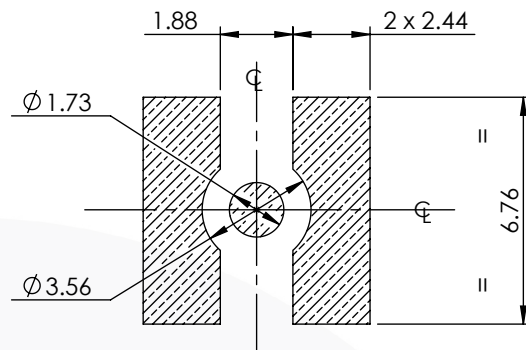
54-453-D3



images for illustration purposes only



RECOMMENDED PCB LAYOUT



Assembly Procedure: Not Applicable

Tooling

Centre Contact: Solder

Tool No: Solder

Crimp Sleeve: Not Applicable

Tool No: Not Applicable

Alignment Tool: Not Applicable

Extraction: Not Applicable

Environmental Specification

Operating Temp: -55 to +155 Deg C.

IP Rating (Mated): IP 40

Electrical Specification

Impedance: 50 Ohm

Frequency: 0-2 GHz

Dielectric W/V: 1000 Veff

Insulation res: 5000 M-Ohm

Mechanical Specification

Contact Retention: 27 N min

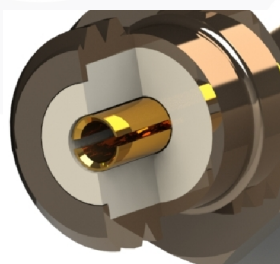
Cable Retention: N/A N min

Mating cycles: 250

Weight: 0.78 g

Connector Interface

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4	GASKET	SILICONE	N/A
3	INSULATOR	PTFE	N/A
2	CENTRE CONTACT	BERYLLIUM COPPER	GOLD
1	BODY	BRASS	GOLD
ITEM	DESCRIPTION	MATERIAL	PLATING

A4	SHEET 1 OF 1	DIMENSIONS ARE IN MILLIMETRES		
REVISION :	A00	NAME	SIGNATURE	DATE
ISSUE :	1	DRAWN	G.E.	21/07/2022
		CHK'D	P.S.	21/07/2022
		APPV'D		
6-8 COLNE ROAD, TWICKENHAM, MIDDLESEX. TW1 4JR				
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